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(12) **United States Design Patent**  
**Ando et al.**

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(54) **HEADPHONE**

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(\*\*) Term: **15 Years**

(21) Appl. No.: **29/592,314**

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(30) **Foreign Application Priority Data**

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(51) **LOC (11) Cl.** ..... **14-01**

(52) **U.S. Cl.**  
USPC ..... **D14/205**

(58) **Field of Classification Search**  
USPC ..... D14/205, 223, 188, 192; D29/112;  
2/209; 181/129, 130, 135; 379/430, 431;  
381/380, 381, 374; 455/90.3, 575.1,  
455/569.1

CPC .... H04R 25/00; H04R 1/1066; H04R 1/1016;  
H04R 5/033; H04R 5/0335; H04R 25/02;  
H04R 1/02

See application file for complete search history.

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(57) **CLAIM**

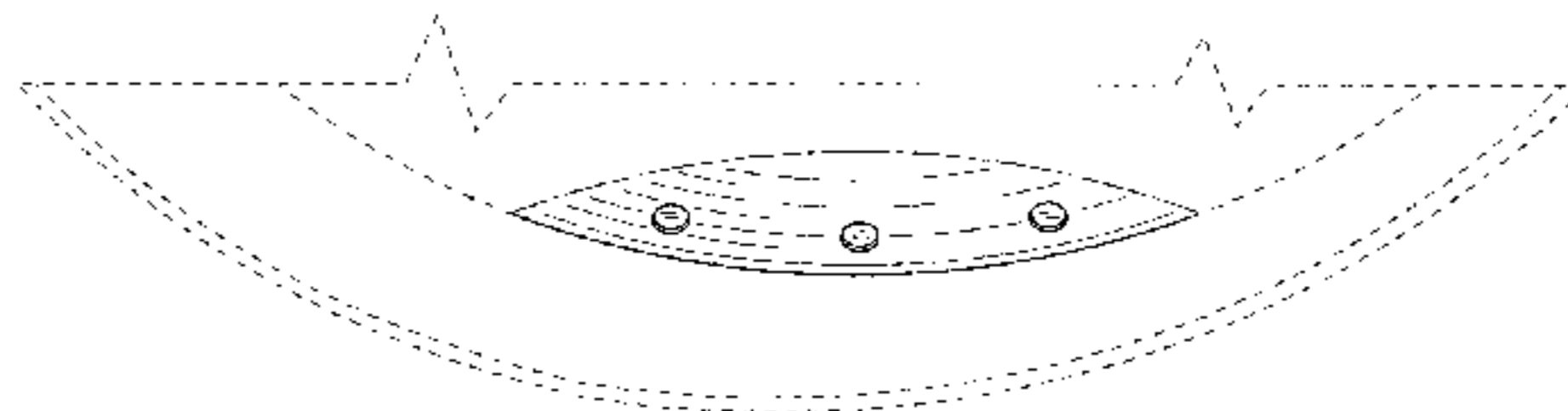
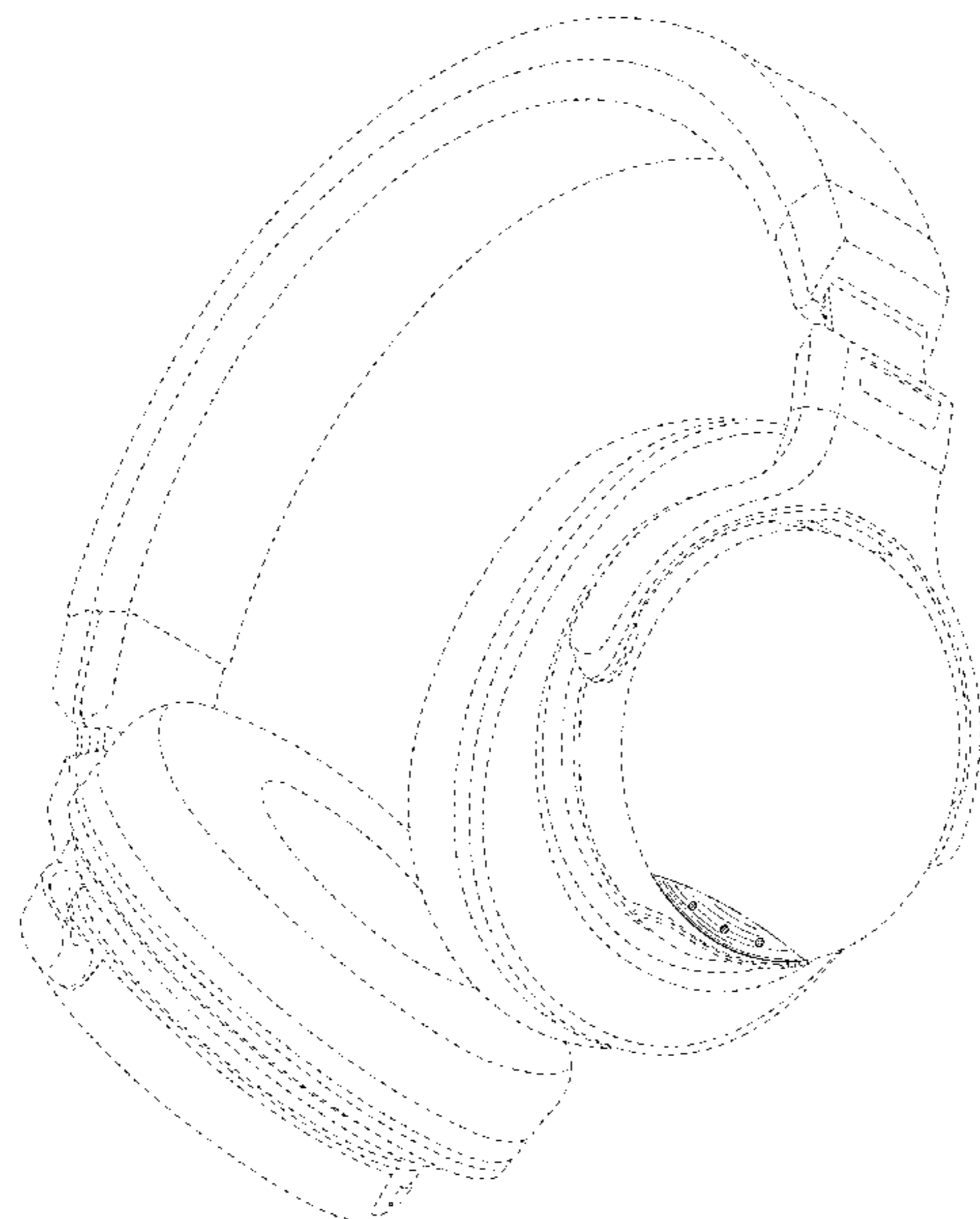
We claim the ornamental design for a headphone, as shown and described.

**DESCRIPTION**

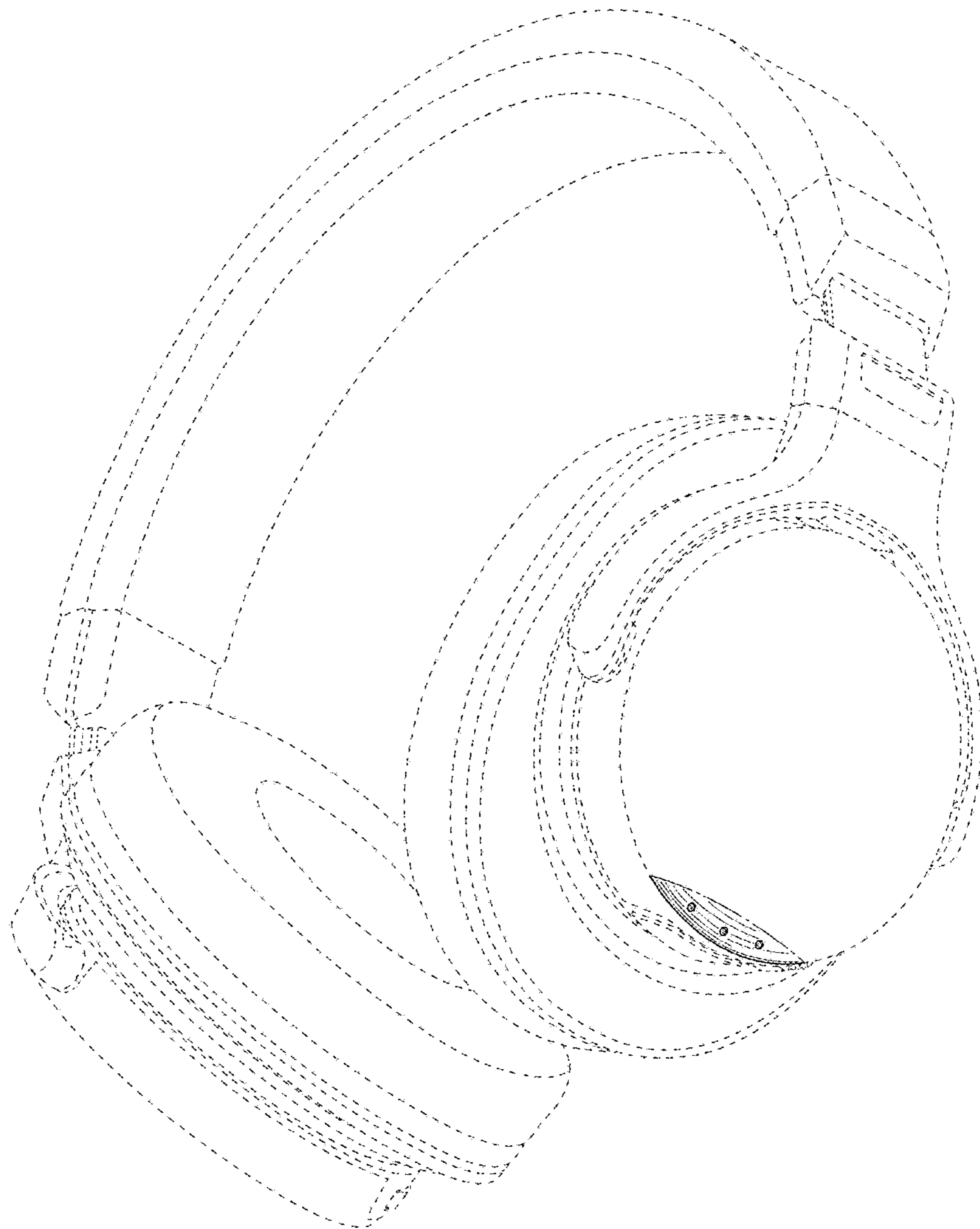
FIG. 1 is a perspective view of a headphone;  
FIG. 2 is a front elevational view of the headphone;  
FIG. 3 is a rear elevational view of the headphone;  
FIG. 4 is a bottom plan view of the headphone;  
FIG. 5 is a right side elevational view of the headphone; and,  
FIG. 6 is an enlarged partial view of the headphone taken from FIG. 5.

The broken lines immediately adjacent the shaded areas represent the bounds of the claimed design while all other broken lines are directed to environment that forms no part of the claimed design.

**1 Claim, 6 Drawing Sheets**



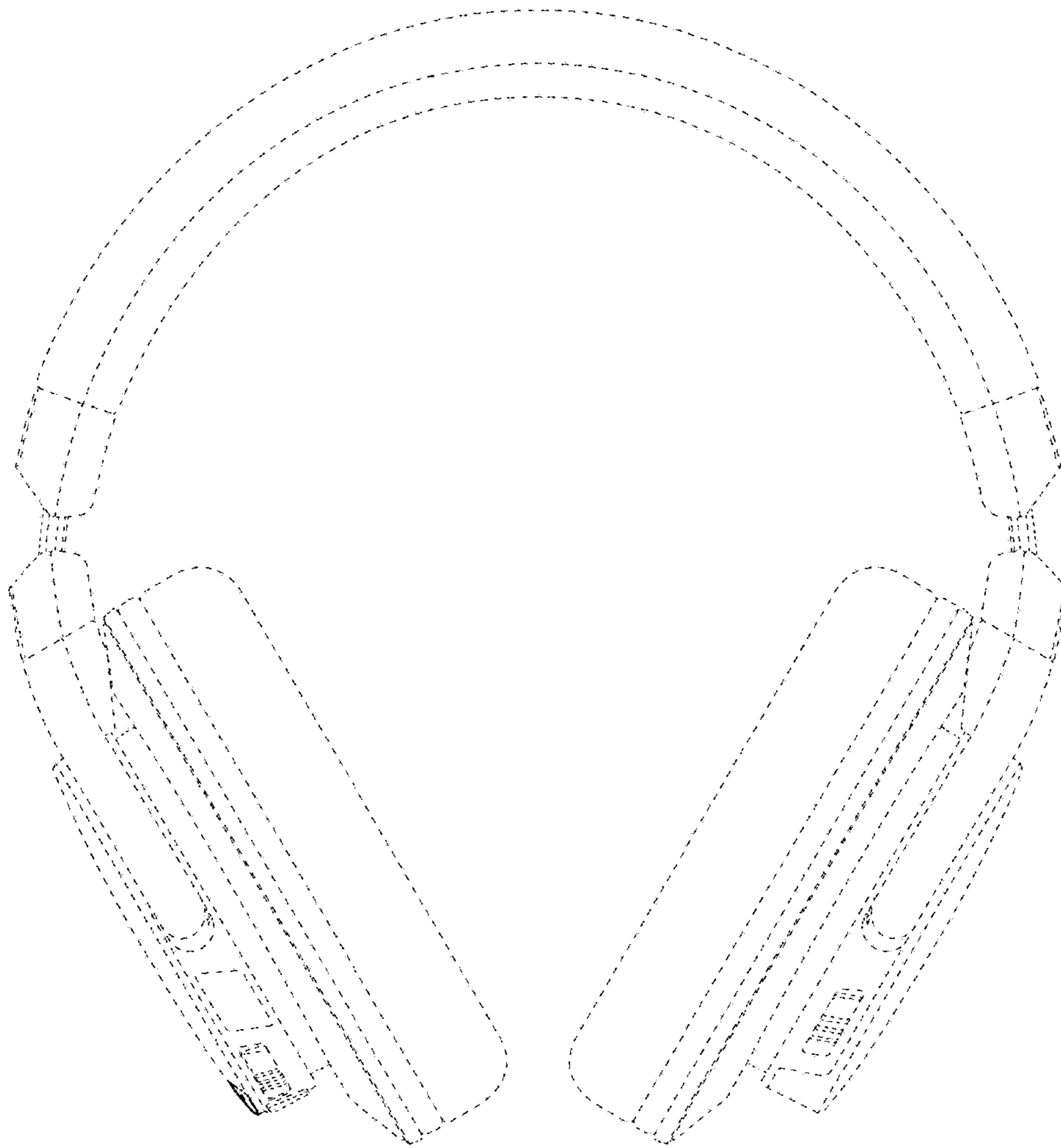
**FIG. 1**



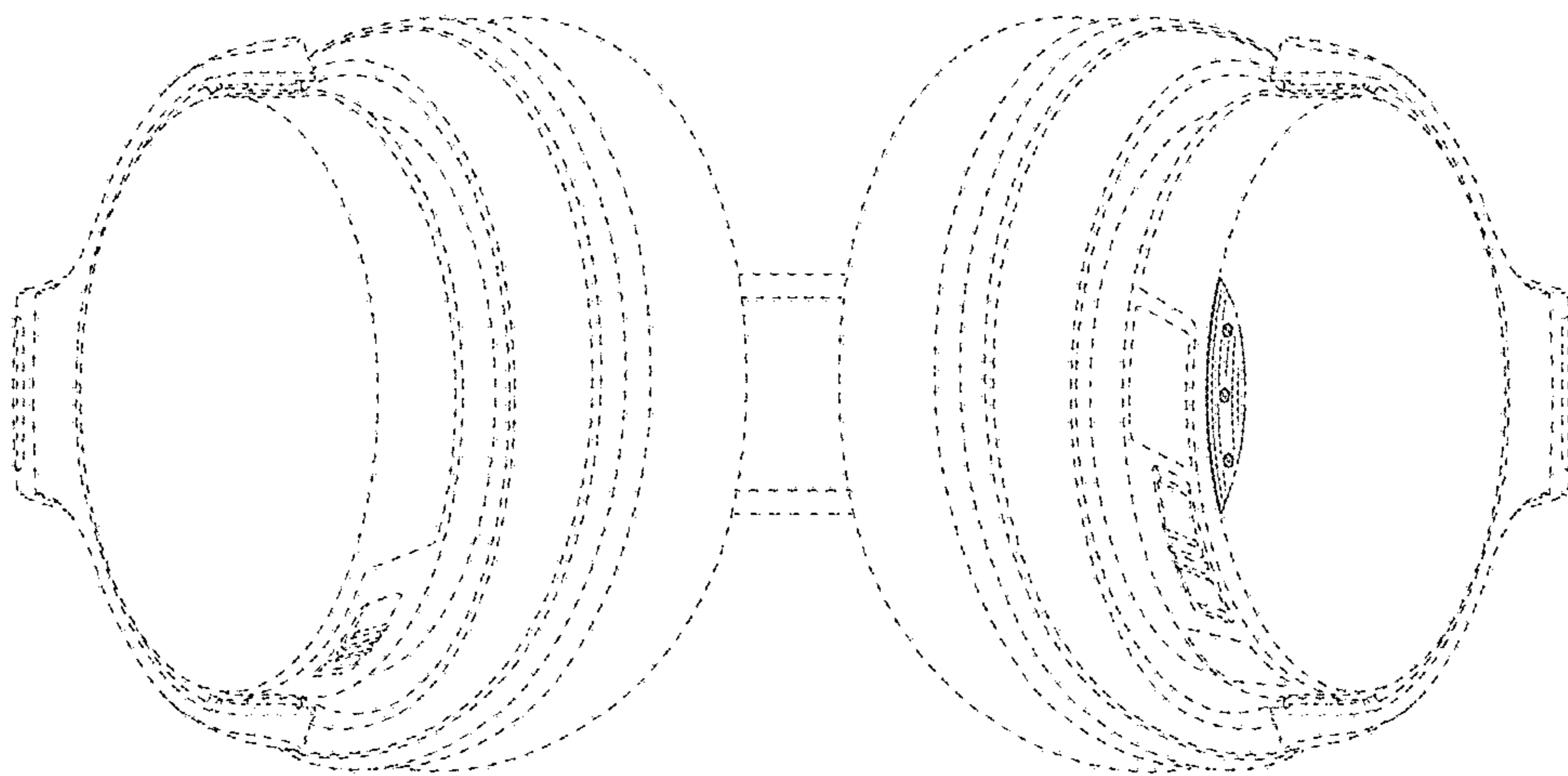
**FIG. 2**



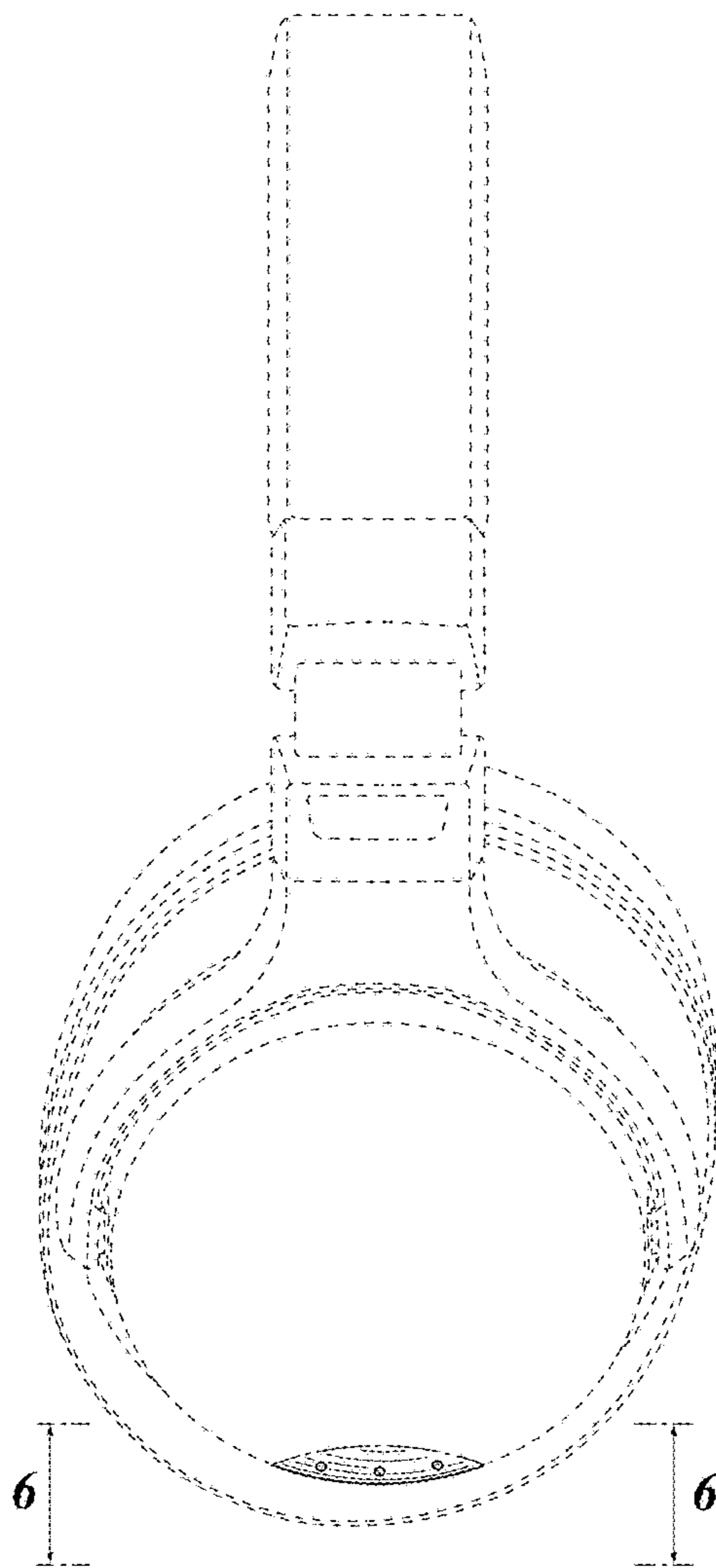
**FIG. 3**



**FIG. 4**



**FIG. 5**



**FIG. 6**

